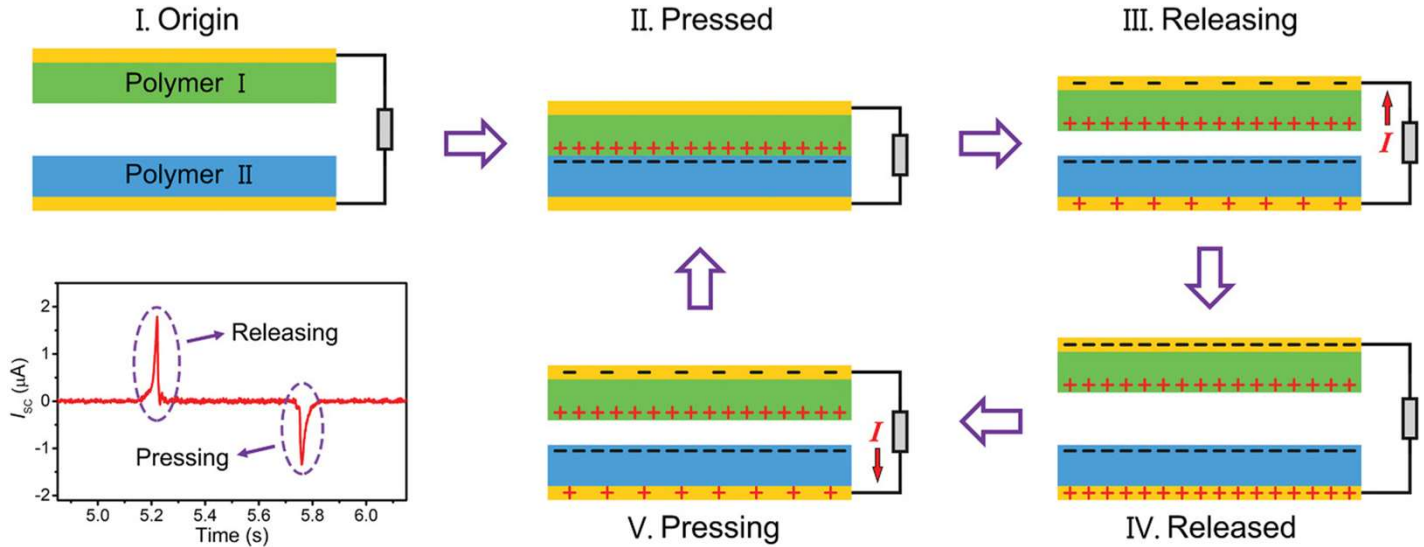


내부 코로나 디스차징 방법을 이용한 코팅 구조 TENG 연구

스마트나노소자 연구실
박상혁

Triboelectric nanogenerator (TENG)



Gauss's law

$$\text{Inside Dielectric 1: } E_1 = -\frac{Q}{S\epsilon_0\epsilon_{r1}}$$

$$\text{Inside the air gap: } E_{air} = \frac{-\frac{Q}{S} + \sigma(t)}{\epsilon_0}$$

$$\text{Inside Dielectric 2: } E_2 = -\frac{Q}{S\epsilon_0\epsilon_{r2}}$$

Electrical potential

$$V = E_1d_1 + E_2d_2 + E_{air}x$$

$$V = -\frac{Q}{S\epsilon_0} \left(\frac{d_1}{\epsilon_{r1}} + \frac{d_2}{\epsilon_{r2}} + x(t) \right) + \frac{\sigma x(t)}{\epsilon_0}$$

V_{oc} (Open-circuit voltage)

$$V_{oc} = \frac{\sigma x(t)}{\epsilon_0}$$

I_{sc} (Short-circuit current)

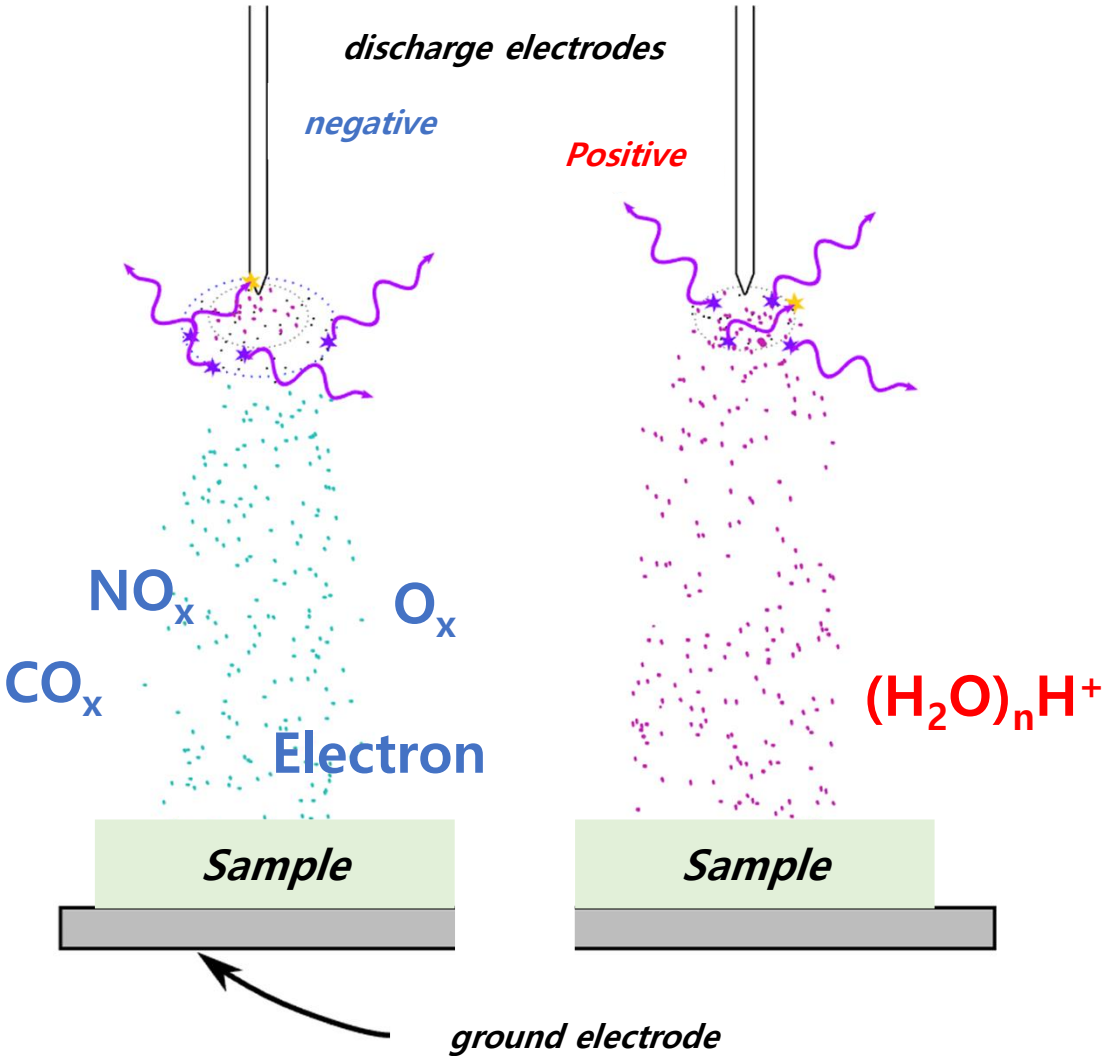
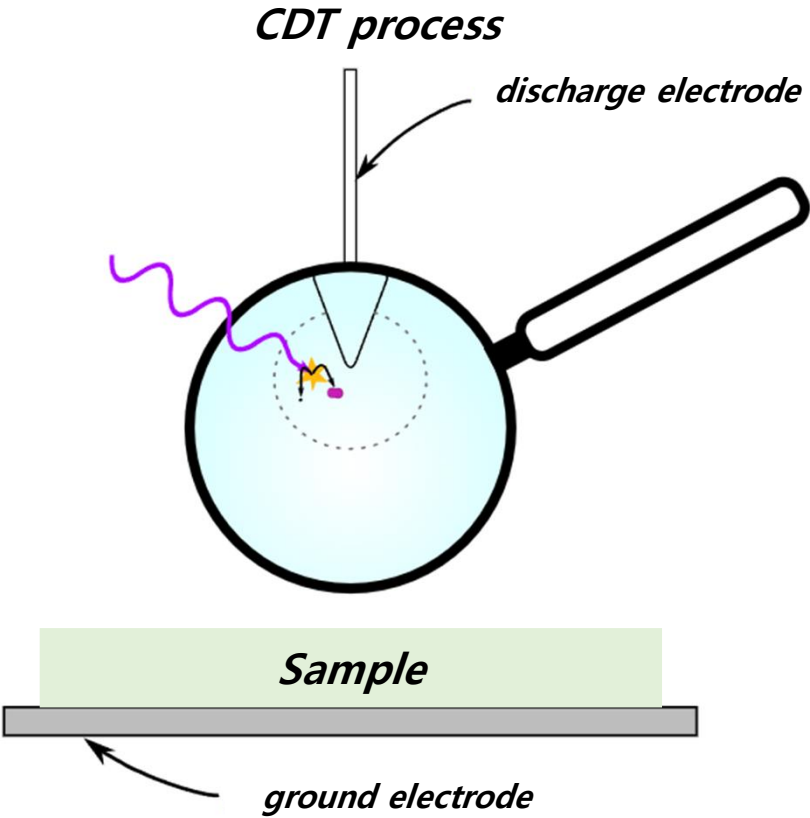
$$Q_{sc} = \frac{S\sigma x(t)}{d_0 + x(t)} \quad I_{sc} = \frac{dQ_{sc}}{dt} = \frac{S\sigma d_0 v(t)}{(d_0 + x(t))^2}$$

* If the motion speed (v) and maximum distance (d) are constant,

$$V_{oc}, I_{sc} \sim \sigma$$

(Surface charge density)

Corona discharge treatment (CDT)



* The CDT process **increases the surface charge** of the sample.

Research objectives

TENG output improvement



Surface charge Improvement



Corona discharge treatment (CDT)



Another treatment method:

Interlayer-corona discharge treatment (i-CDT)

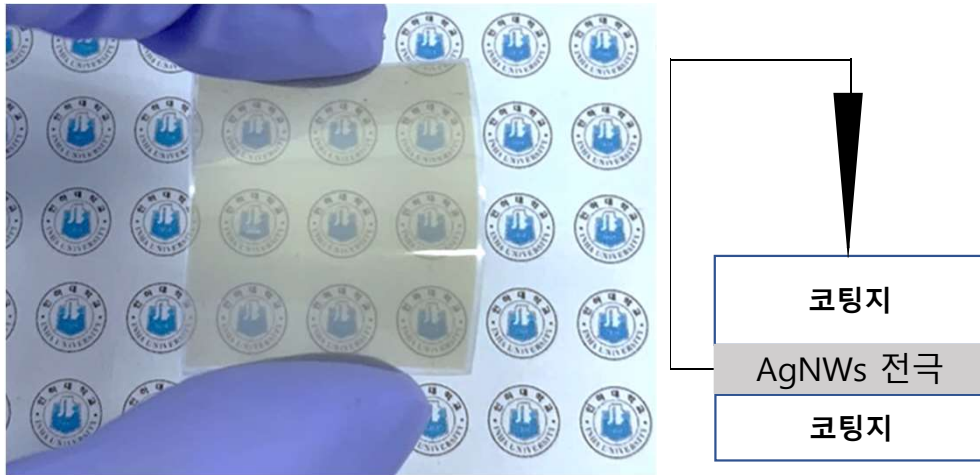


Unstable surface condition:

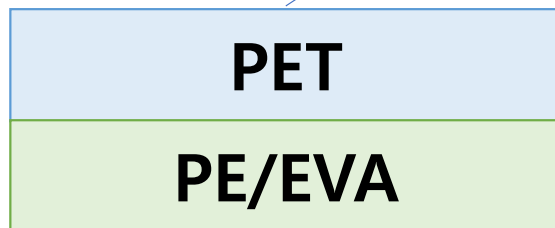
***Decreased output over time**
***Easy charge discharge on surface**

Surface CDT (s-CDT) : Laminated structure with AgNWs

* Laminating structure



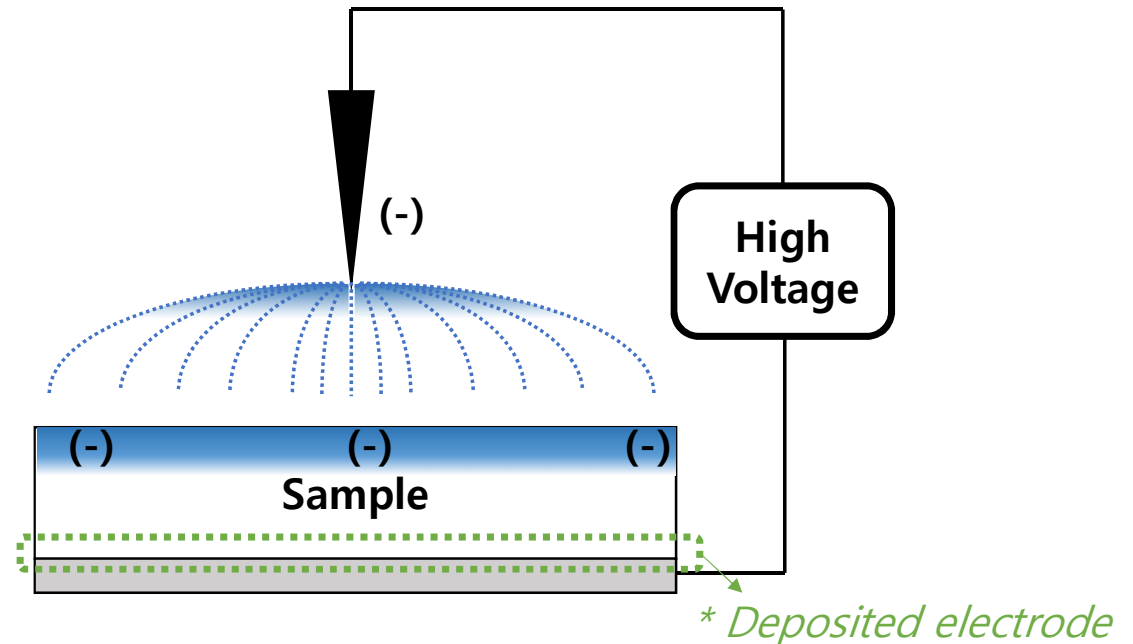
* Laminating film



*Contact electrification part
(Surface part)*

*Electrode deposition part
(interlayer part)*

Negative surface-CDT



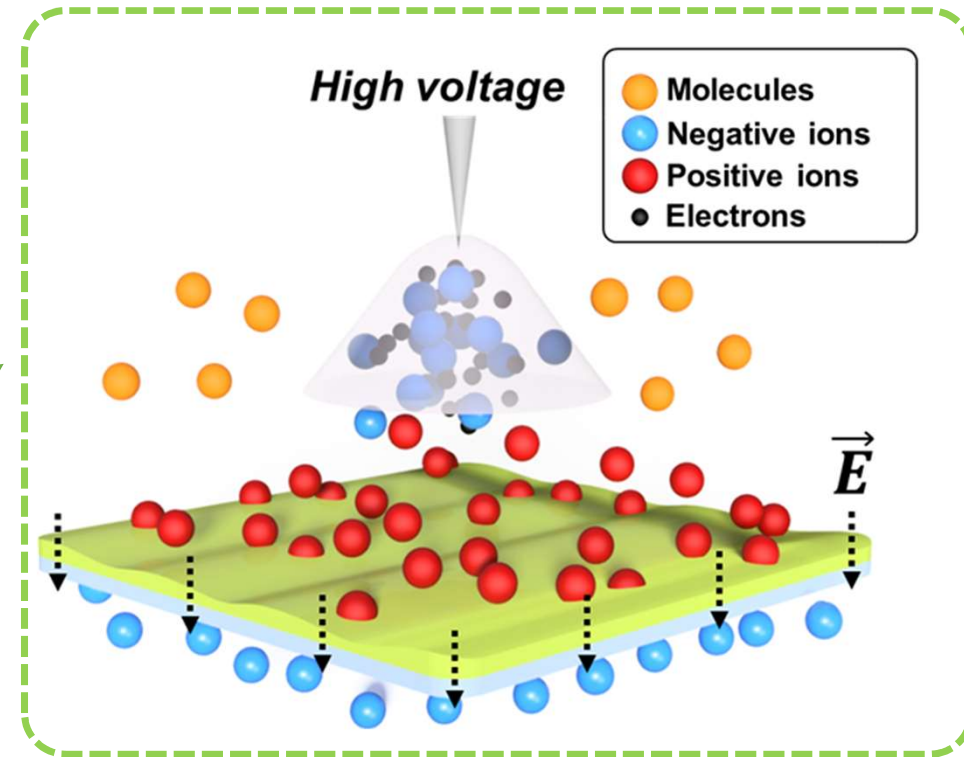
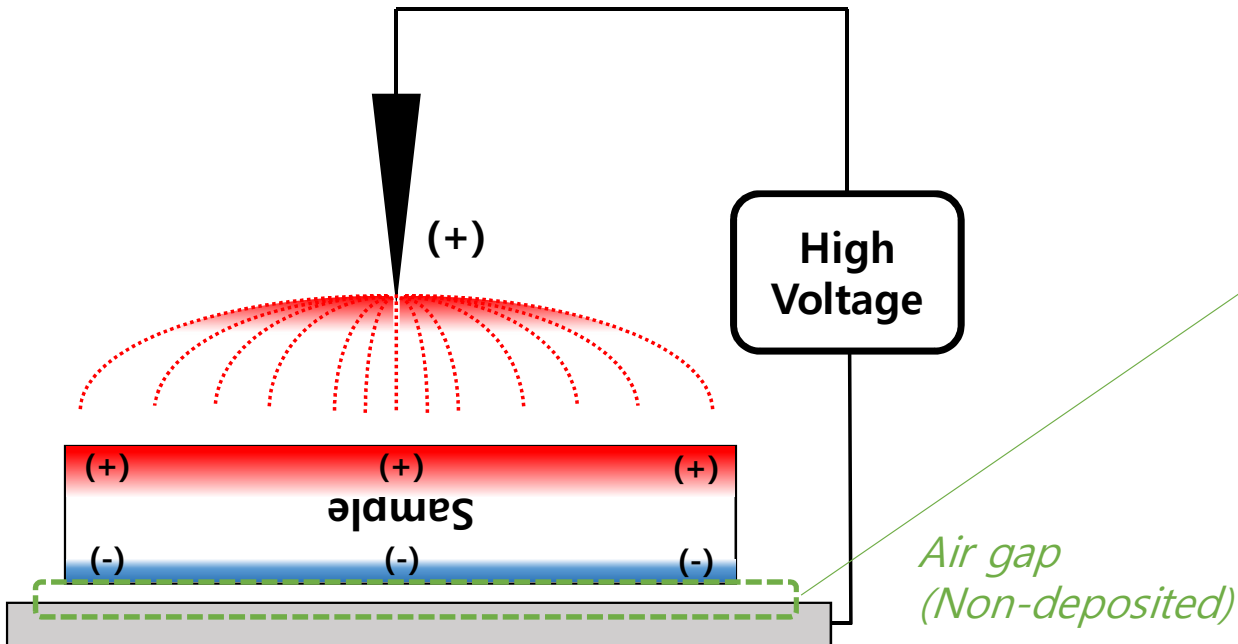
Discharge Tip Bias : **Negative (-)**

Charge on the sample surface : **Negative (-)**

=> **It's the same sign as each other.**

Interlayer CDT (i-CDT)

Positive surface-CDT



Discharge Tip Bias : **Positive (+)**

Charge on the sample surface : **Negative (-)**

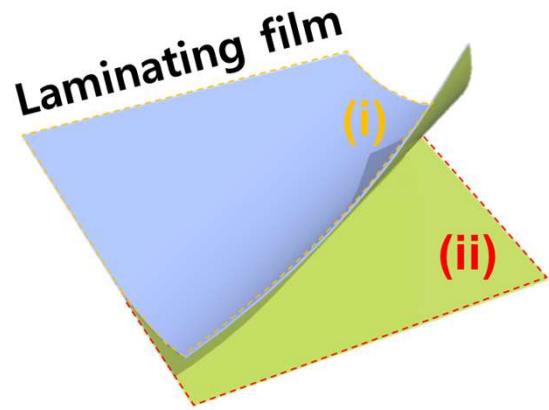
=> **It's the opposite sign as each other.**

Where did the negative charge come from?

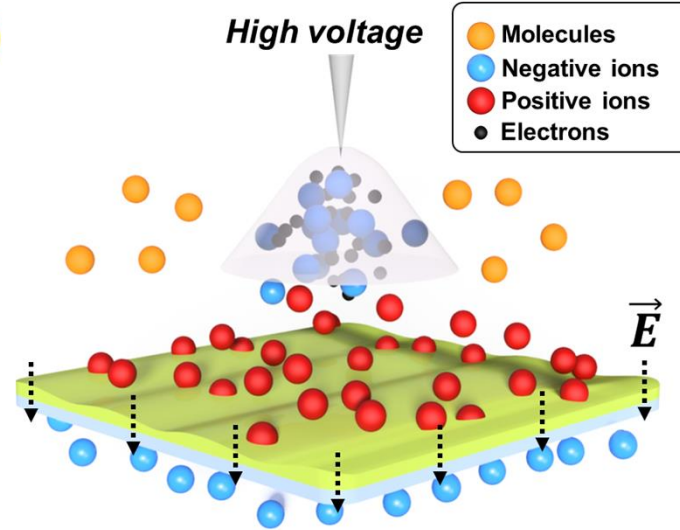
=> **Negative ions in the air or Electrons?**

Fabrication of i-CDT film

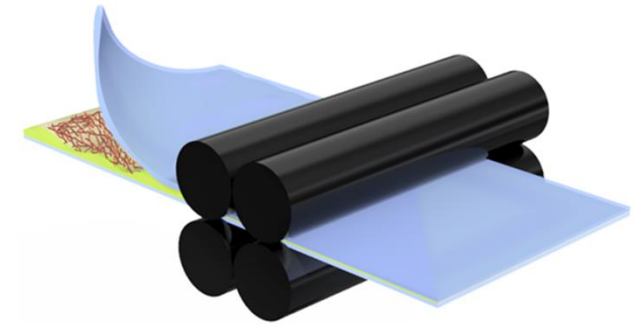
Laminating Structure with Ag NWs for TNEG applications



(i)

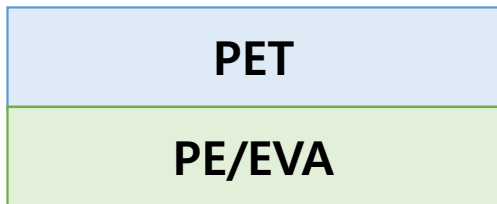


In pressing with heat & pressure



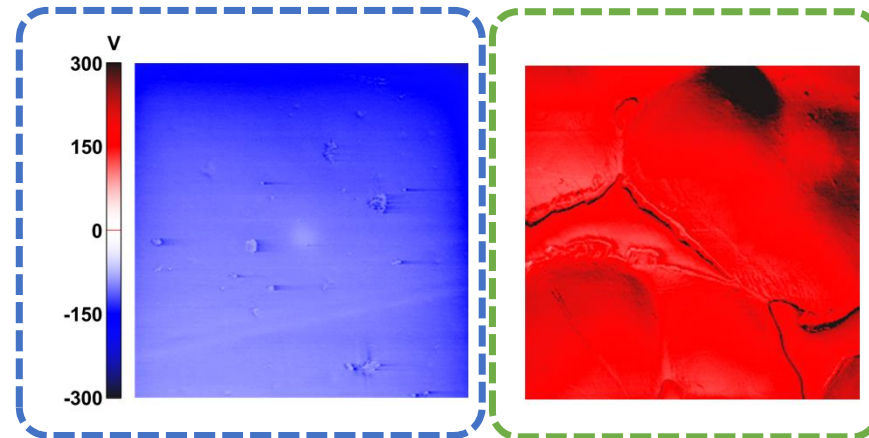
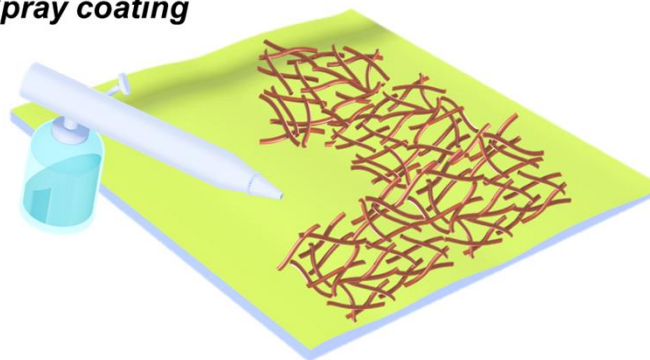
EFM image (after i-CDT)

Contact electrification part
(Surface part)



(ii)

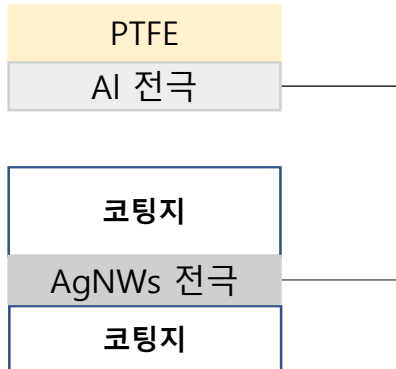
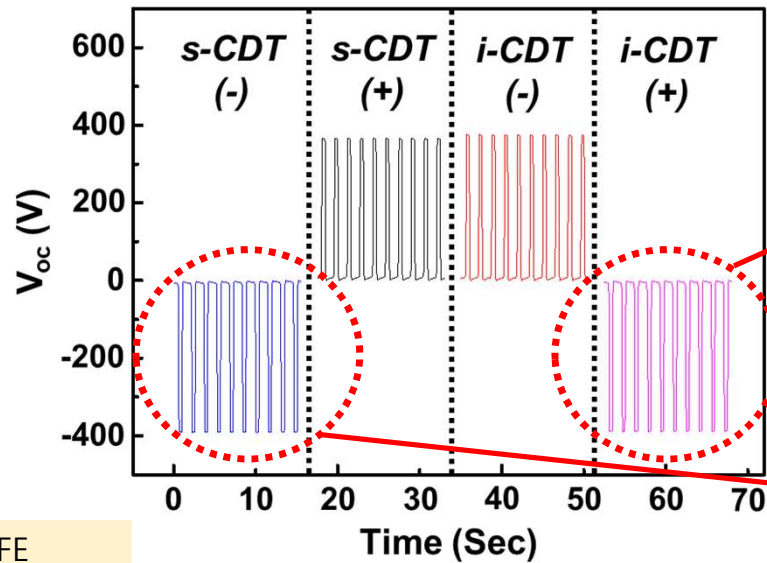
Spray coating



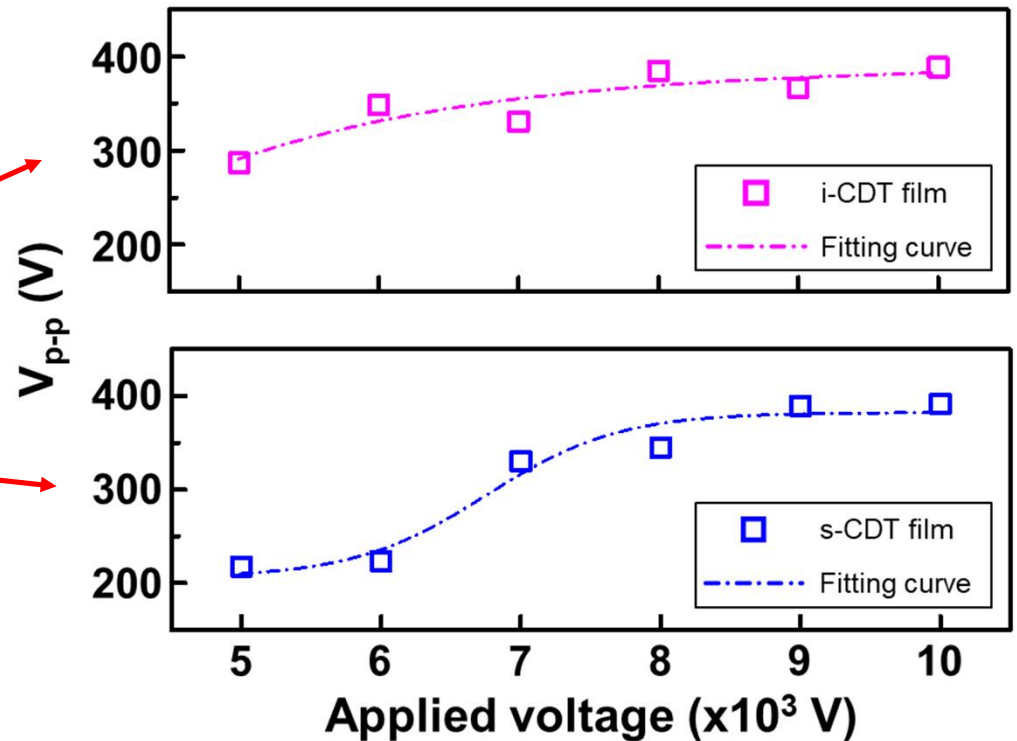
Electrode deposition part
(interlayer part)

s-CDT vs i-CDT : Triboelectric output (2.5 x 2.5 cm²)

Triboelectric voltage by the polarity of CDT (10kV)

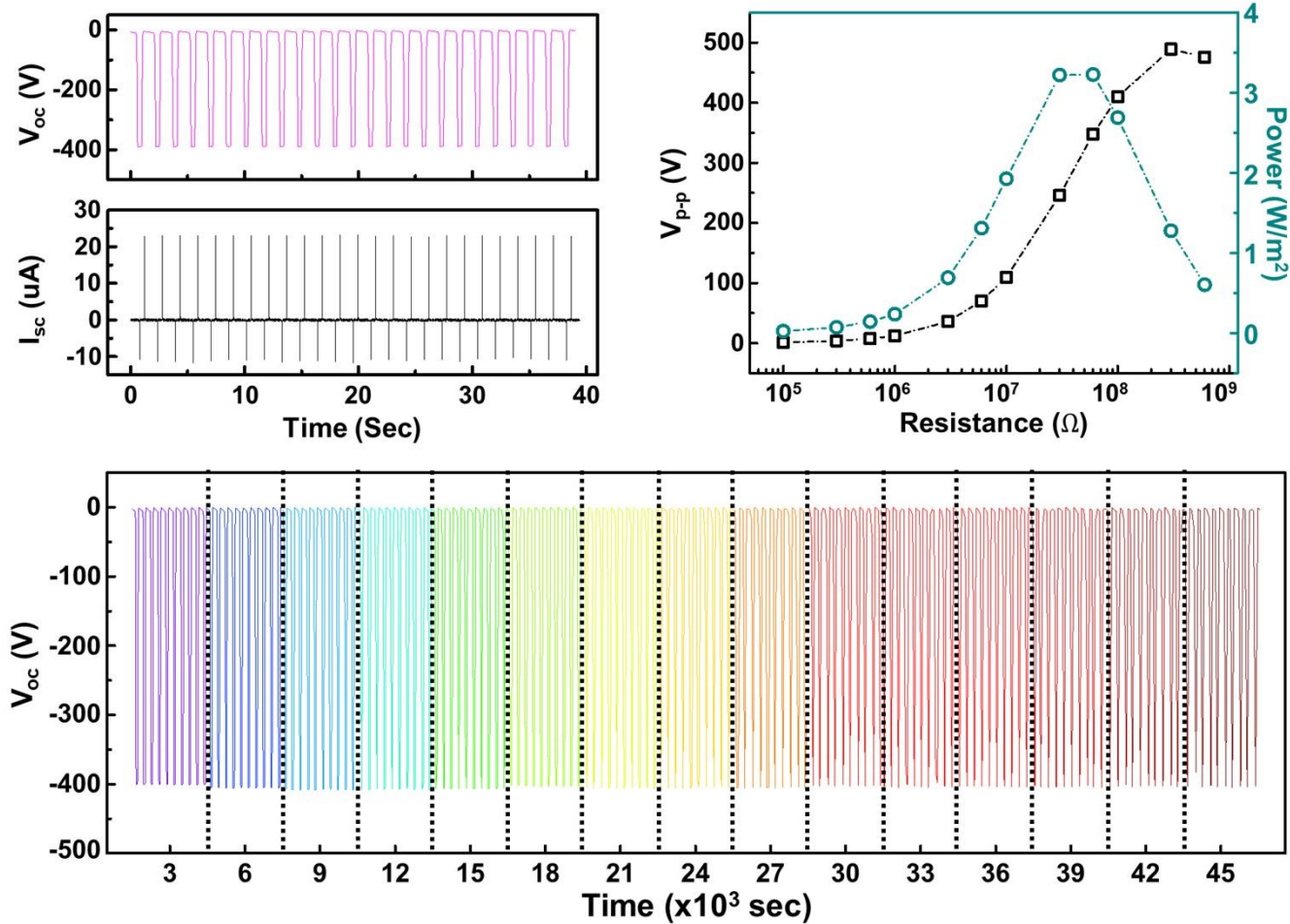


Triboelectric voltage by the applied voltage of CDT

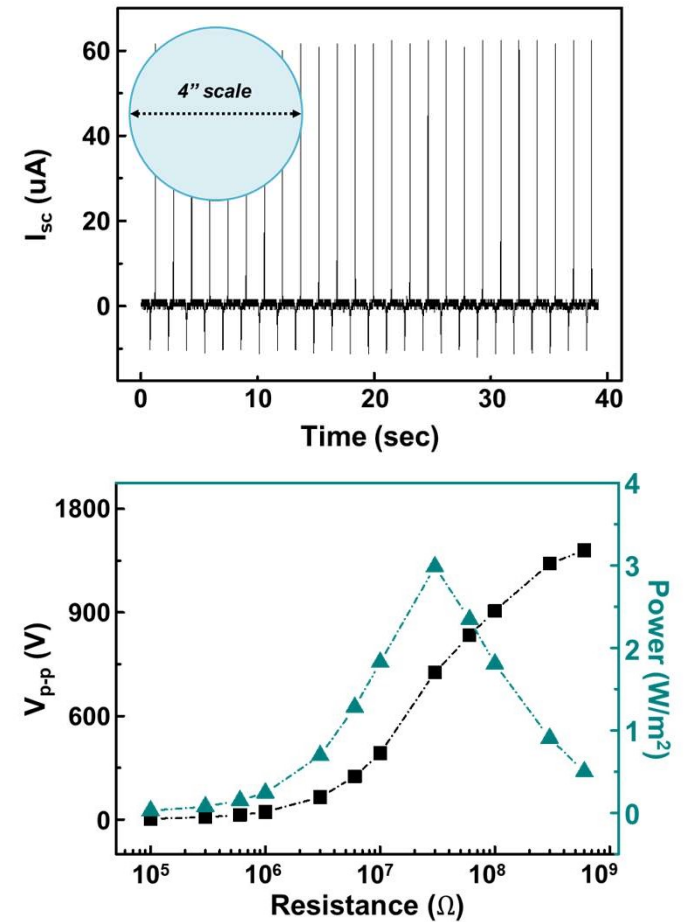


Triboelectric output of i-CDT

Triboelectric output of i-CDT (2.5x 2.5 cm²)

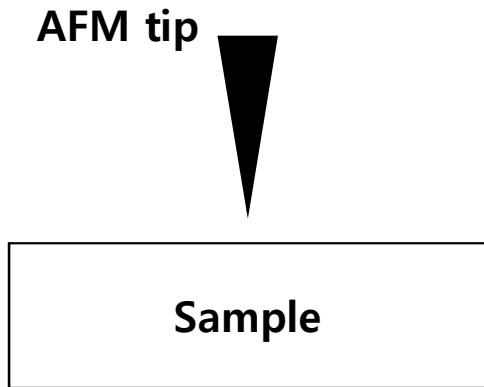


Large area (4"-scale)

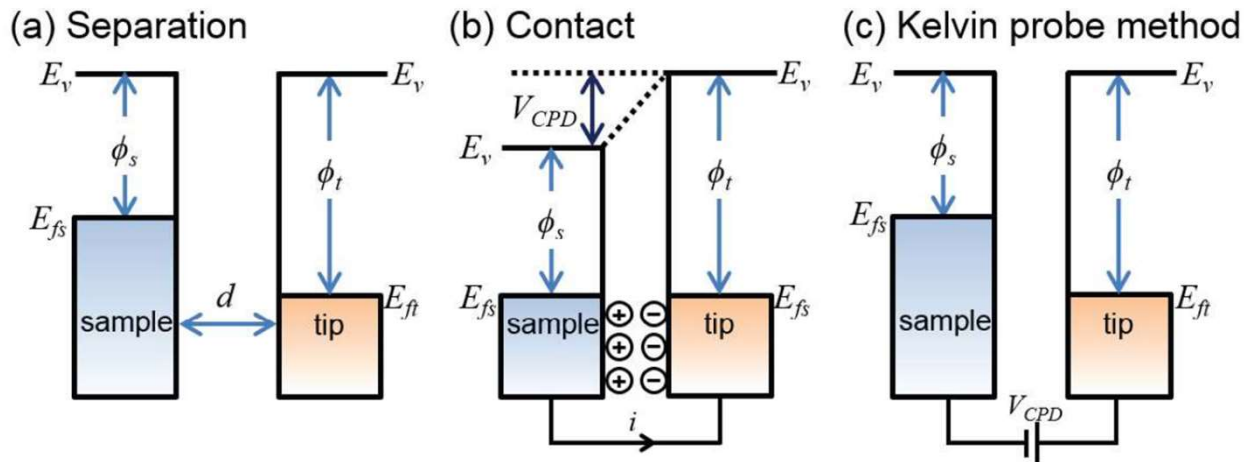
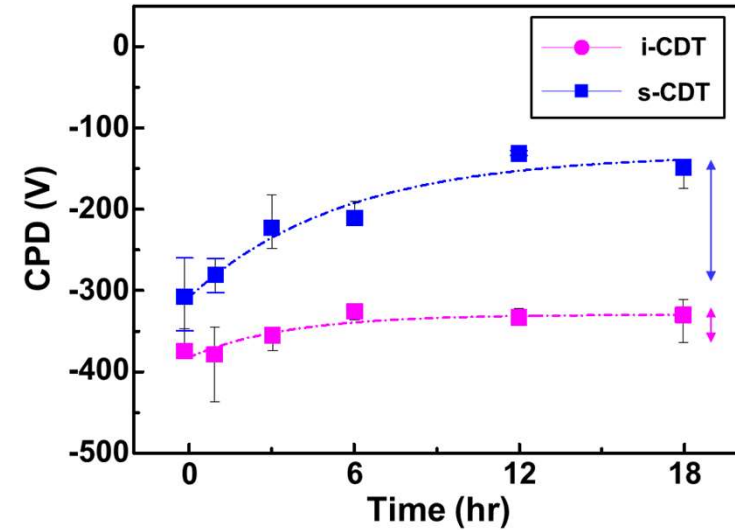


i-CDT: *Where did the negative charge come from?*

CPD (Contact potential difference) by AFM



$$V_{CPD} = \frac{\phi_{tip} - \phi_{sample}}{-e}$$



$$\sigma = \sigma_{electron} + \sigma_{ion}$$

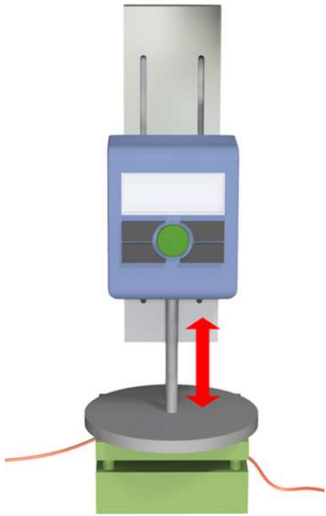
$$\sigma_{electron} = \sigma_0 e^{-\gamma t} \quad \text{unstable}$$

$$\sigma_{ion} = \sigma'_0 \quad \text{stable}$$

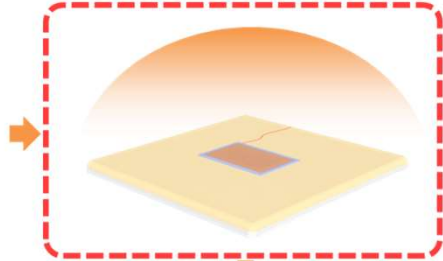
i-CDT has more ion contribution than s-CDT.

s-CDT < i-CDT : Charge retention in various temperature

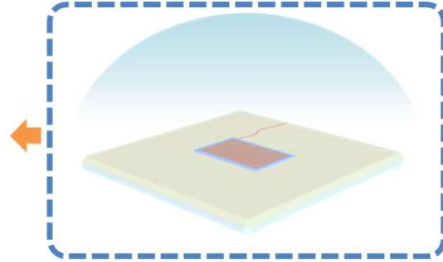
Working TENG
Pushing machine



Heating in oven (60 min)

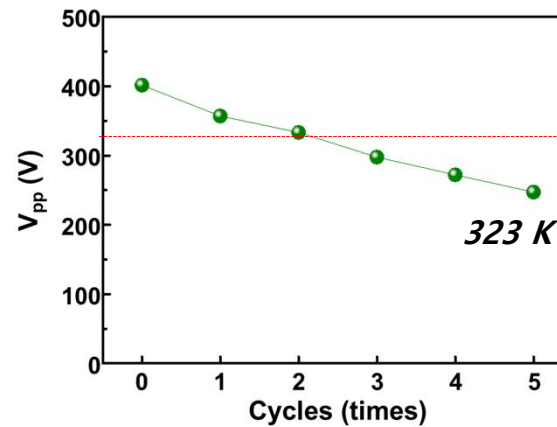
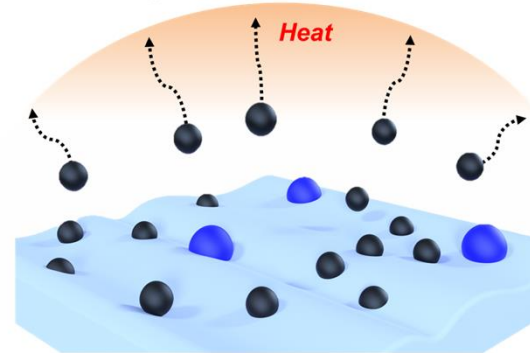


Cooling in air (30 min)



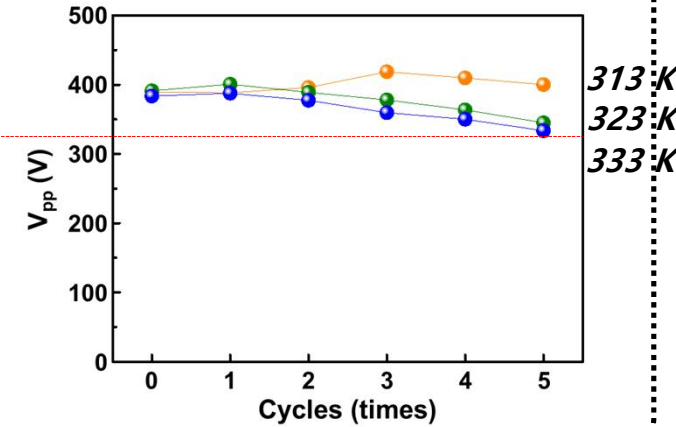
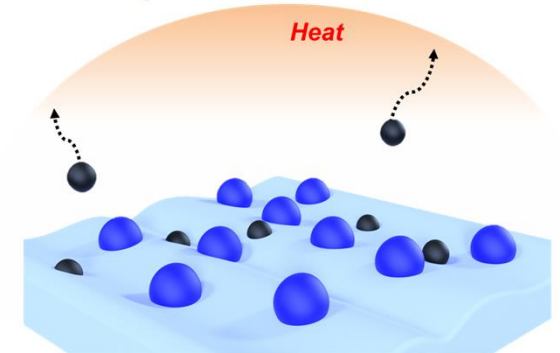
s-CDT

Relatively unstable



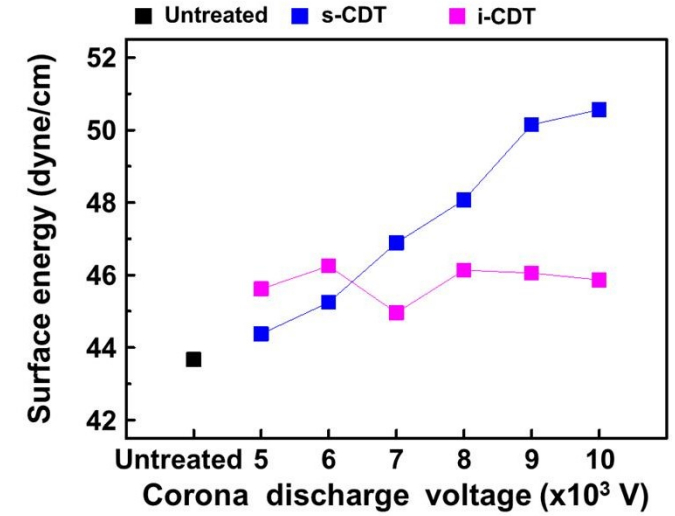
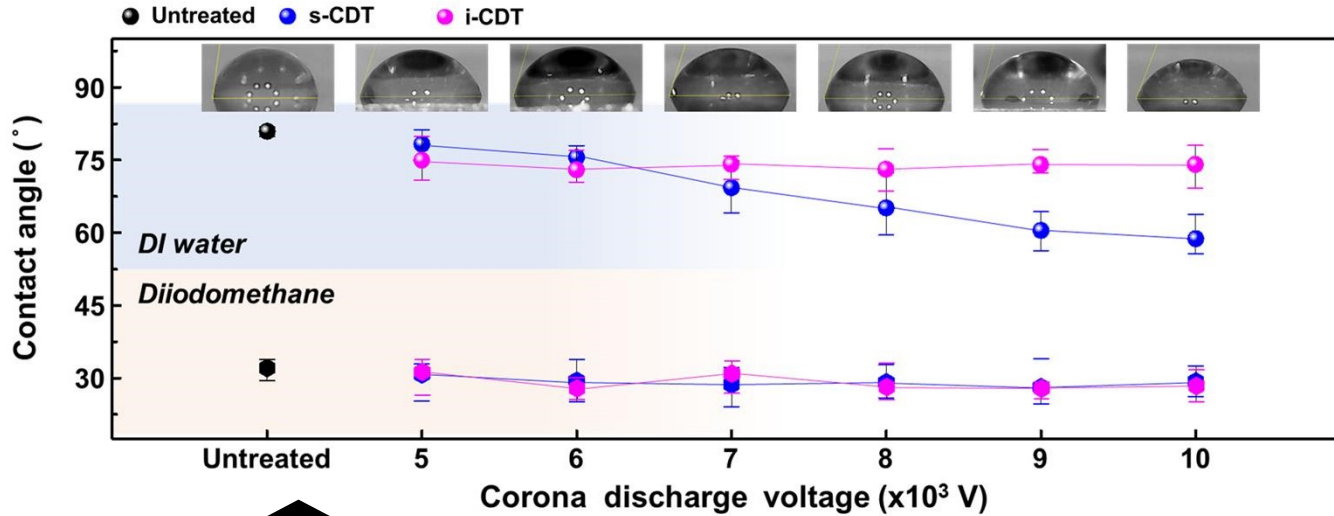
i-CDT

Relatively stable



s-CDT < i-CDT : Charge retention in high humidity condition

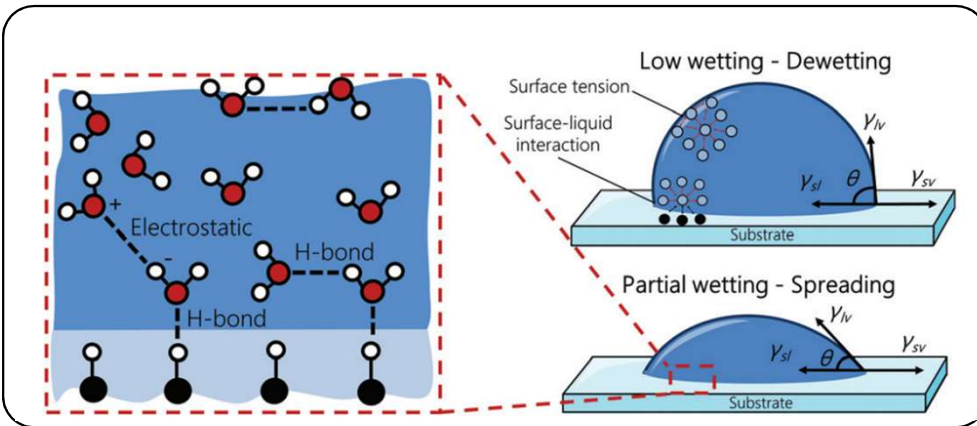
Contact angle measurement & Surface energy calculation



Owen-Wendt equation

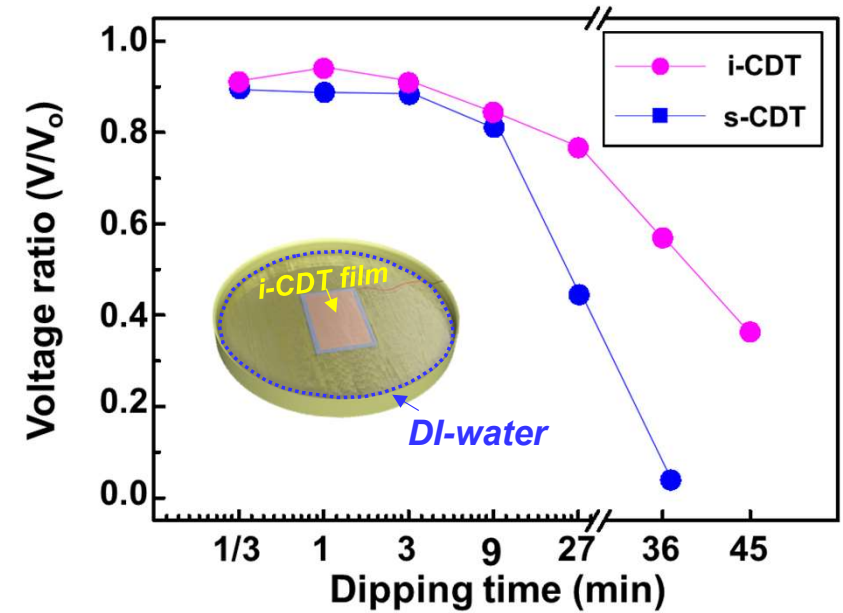
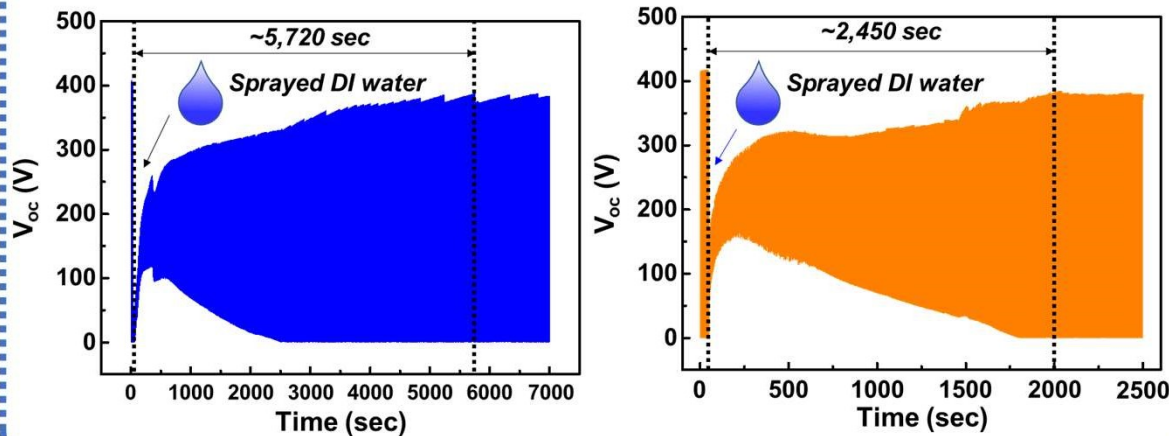
$$(\gamma_s^p)^{0,5} = \frac{\gamma_w(\cos \Theta_w + 1) - 2\sqrt{\gamma_s^d \gamma_w^d}}{2\sqrt{\gamma_w^p}}$$

$$(\gamma_s^d)^{0,5} = \frac{\gamma_d(\cos \Theta_d + 1) - \sqrt{(\gamma_d^p/\gamma_w^p)\gamma_w(\cos \Theta_w + 1)}}{2(\sqrt{\gamma_d^d} - \sqrt{\gamma_d^p(\gamma_w^p/\gamma_w^p)})}$$



s-CDT < i-CDT : Charge retention in high humidity condition

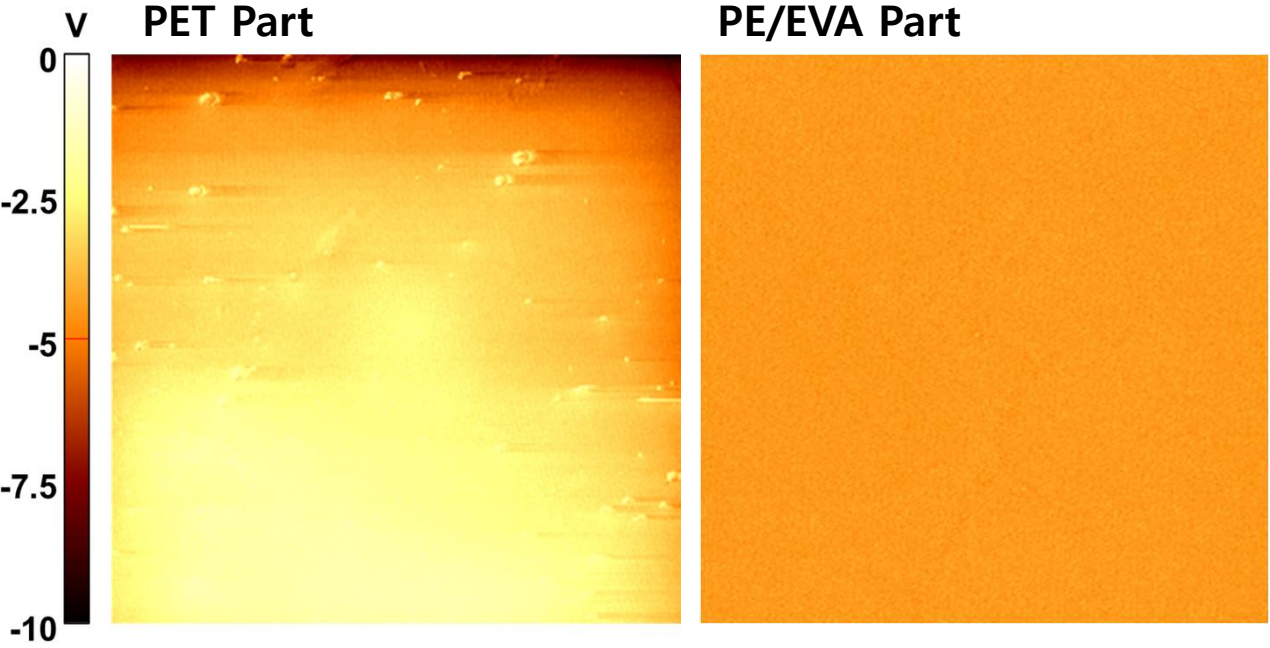
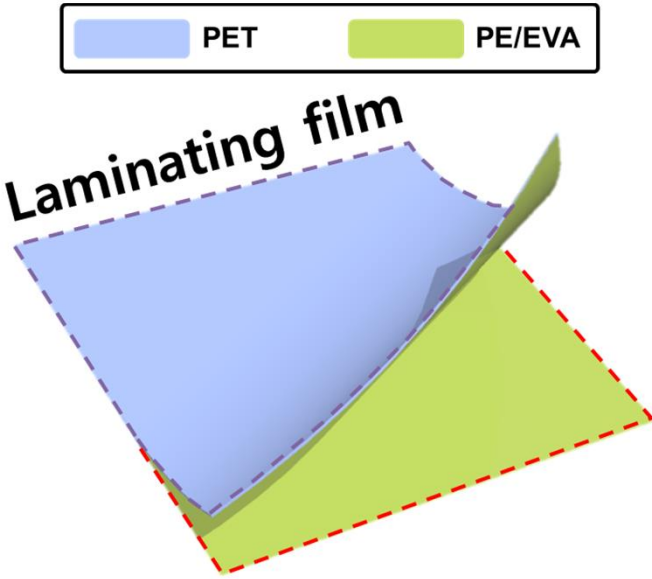
The test of resistance and recovery ability about water by spraying DI-water during TENG working



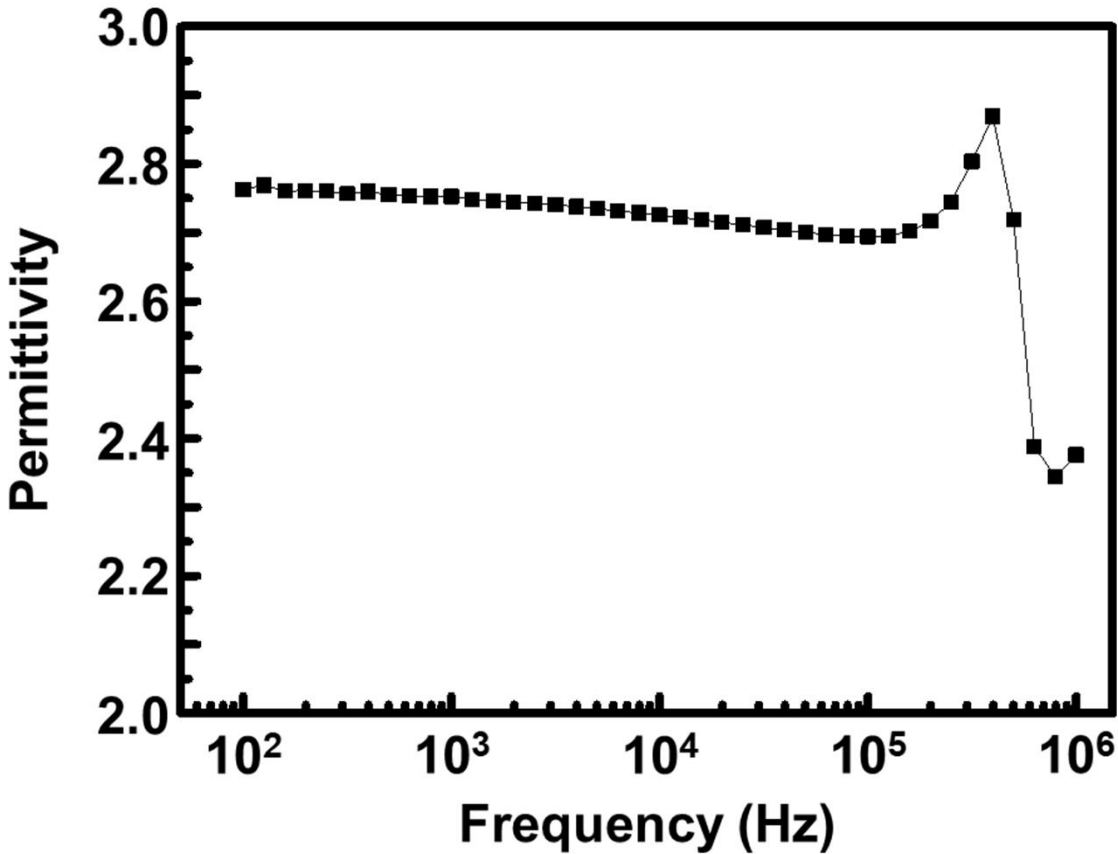
*i-CDT is relatively **lower surface energy** than s-CDT and is **better resistant to water**.*

Q & A

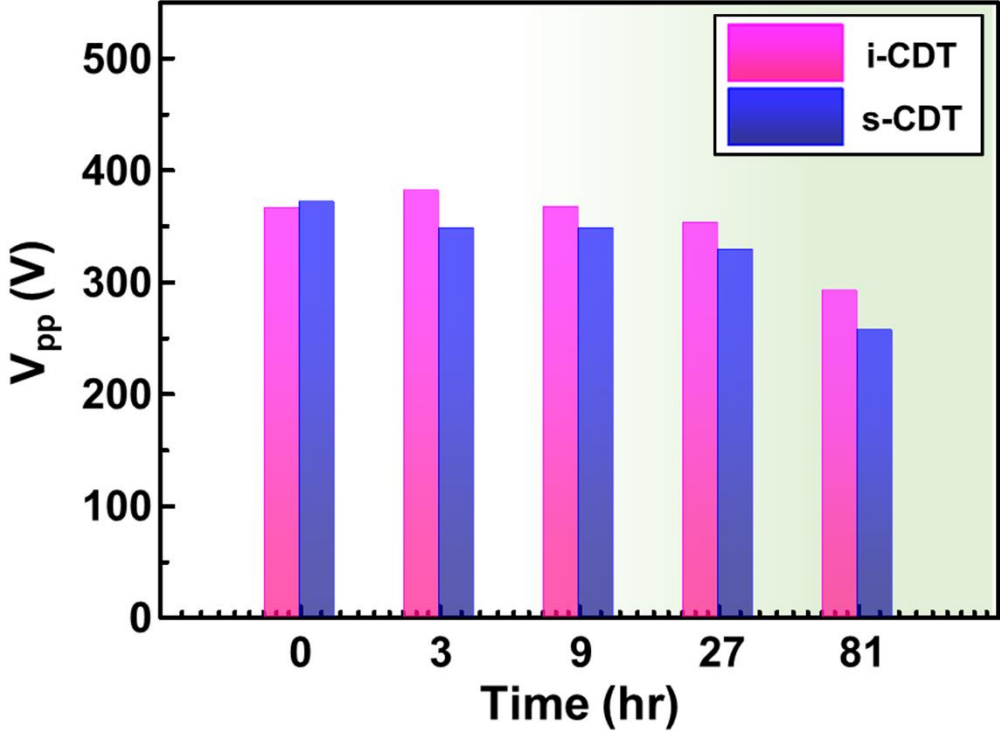
Supporting information 1. EFM image of Non-CDT laminating structure



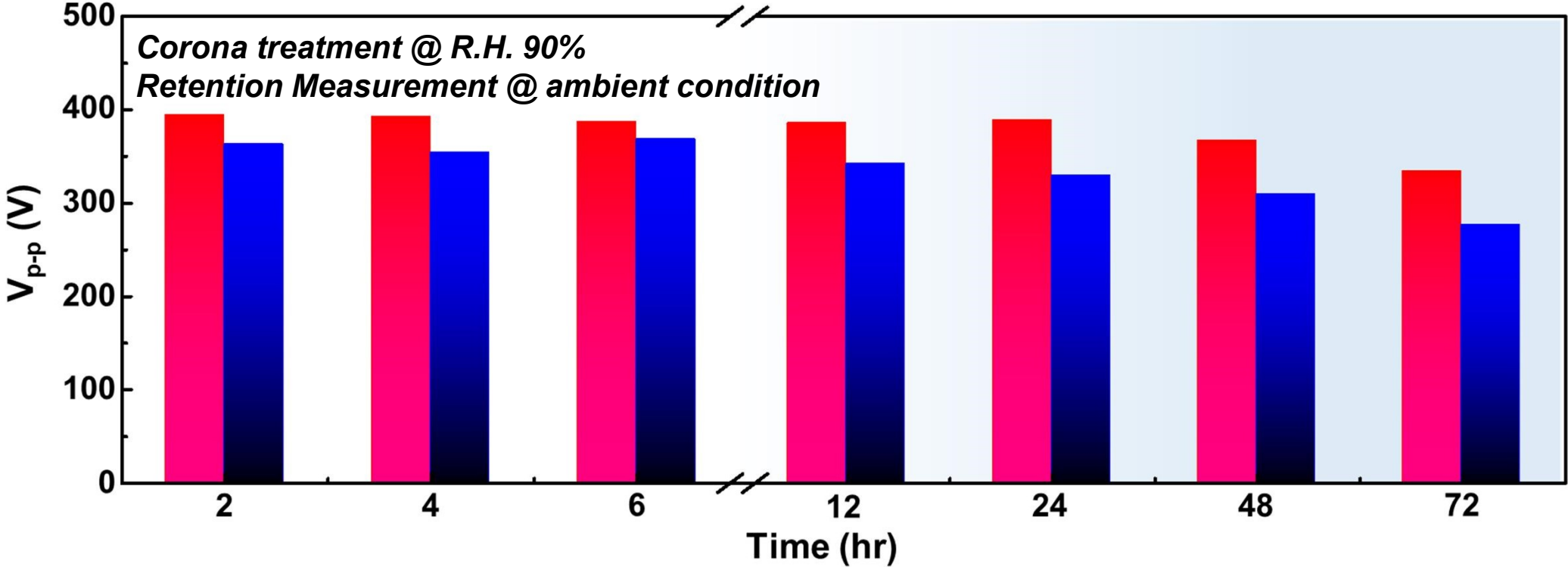
Supporting information 2. permittivity of laminating structure



Supporting information 2. Long-lasting stability test of i-CDT and s-CDT



Supporting information 3. Long-lasting stability test of i-CDT and s-CDT in high humidity condition



Supporting information 4. Surface roughness and images measurement by optical profilometer

